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EMIF03-SIM05F3

EMI filter with SWP protection for SIM interface

Datasheet - production data

Features

- Lead-free package
- Very low PCB space consumption
- Very thin package: < 0.55 mm after reflow
- High efficiency in ESD suppression IEC6 1000-4-2 level 4
- High reliability offered by monolithic integration
- High reduction of parasitic elements through integration and WLCSP packaging

Complies with the following standards:

- IEC 61000-4-2 level 4
 - ± 15 kV (air discharge)
 - ± 8 kV (contact discharge)

Application

■ Mobile phones

Description

The EMIF03-SIM05F3 is a highly integrated device designed to protect SIM interface and SWP line against ESD transients and EMI emission.

The device is the ideal fit for applications using NFC.

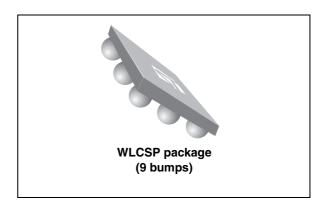


Figure 1. Pin configuration (bump side)

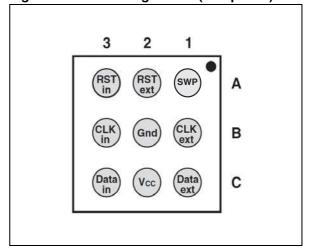
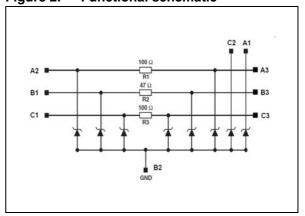


Figure 2. Functional schematic



Characteristics EMIF03-SIM05F3

1 Characteristics

Table 1. Absolute maximum ratings ($T_{amb} = 25$ °C)

Symbol	Parameter	Value	Unit
V _{PP}	Internal pins (A3, B3, C3): ESD discharge IEC 61000-4-2 ⁽¹⁾ , level 1 Air discharge Contact discharge External pins (A1, A2, B1, C1, C2): ESD discharge IEC 61000-4-2, level 4 Air discharge Contact discharge	2 2 16 16	kV
T _j	Maximum junction temperature	150	
T _{op}	Operating temperature range	- 30 to + 85	°C
T _{stg}	Storage temperature range	- 55 to 150	

Measurements done on IEC 61000-4-2 test bench. For further details see Application note AN3353, "IEC 61000-4-2 standard testing".

Figure 3. Electrical characteristics (definitions)

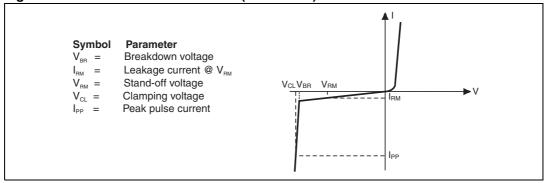


Table 2. Electrical characteristics ($T_{amb} = 25$ °C)

Symbol	Test conditions	Min.	Тур.	Max.	Unit
I _{RM}	V _{RM} = 3 V			100	nA
V _{BR}	I _R = 1 mA	6			٧
R1 _, R3	RST, DATA serial resistor		100		Ω
R2	CLK serial resistor		47		52
C _{line}	Line capacitance on RST, DATA, CLK lines $V_{line} = 0 \text{ V}, V_{osc} = 30 \text{ mV}, F = 1 \text{ MHz}$ (measured under zero light conditions)		12		pF
C _{SWP}	Line capacitance on SWP line $V_{line} = 0 \text{ V}, V_{osc} = 30 \text{ mV}, F = 1 \text{ MHz}$ (measured under zero light conditions)		2	3	pF

EMIF03-SIM05F3 **Characteristics**

Attenuation measurements C1-C3, Figure 5. **Attenuation measurements A1-C2** Figure 4. A2-A3, B1-B3

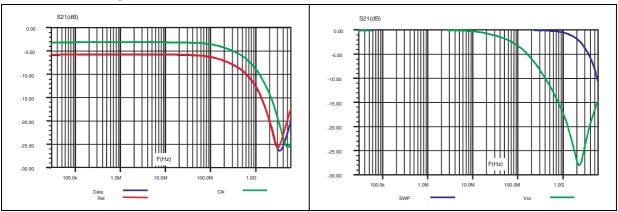


Figure 6. **Analog Xtalk measurements**

Figure 7. Digital crosstalk measurements LeCroy V_{CLK} = 3 V t_R = t_F = 2 ns -10.00 -40.00 -60.00 -70.00 -90.00 -110.00

Figure 9. Figure 8. Dynamic characteristic (SWP) Dynamic characteristic (V_{CC}) 28 28 26 24 26 24 22 20 18 16 14 12 10 8 12 15

Characteristics EMIF03-SIM05F3

Figure 10. ESD response to IEC 61000-4-2 (+8 kV contact discharge) CLK line

Figure 11. ESD response to IEC 61000-4-2 (-8 kV contact discharge) CLK line

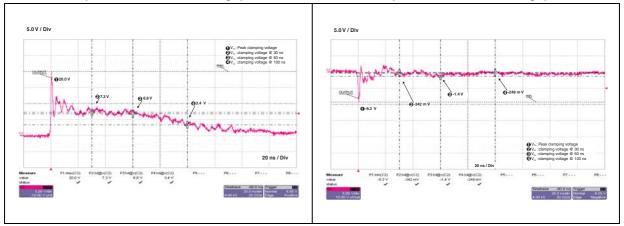
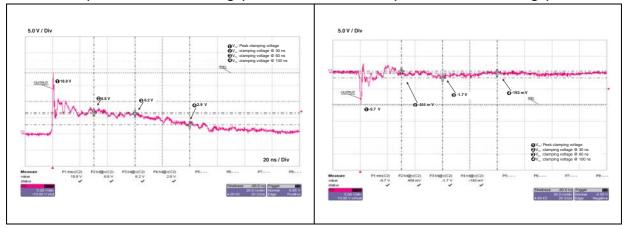


Figure 12. ESD response to IEC 61000-4-2 (+8 kV contact discharge) DATA line

Figure 13. ESD response to IEC 61000-4-2 (-8 kV contact discharge) DATA line



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Figure 14. ESD response to IEC 61000-4-2 (+8 kV contact discharge) SWP line

Figure 15. ESD response to IEC 61000-4-2 (-8 kV contact discharge) SWP line

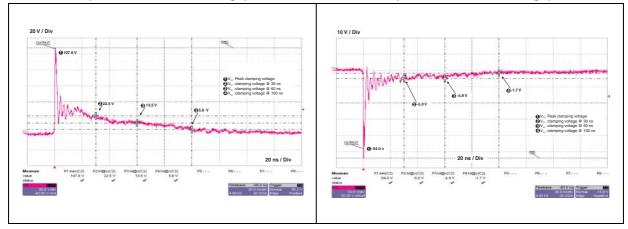
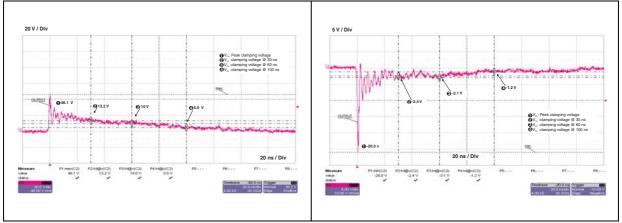


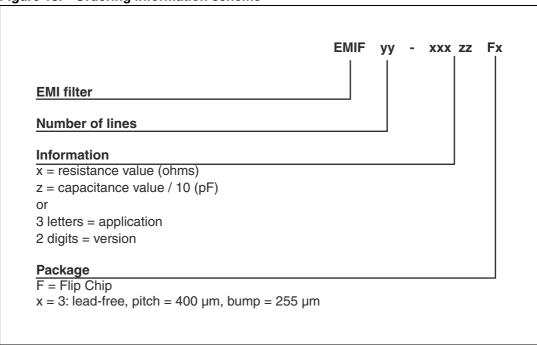
Figure 16. ESD response to IEC 61000-4-2 (+8 kV contact discharge) V_{CC} line

Figure 17. ESD response to IEC 61000-4-2 (-8 kV contact discharge) V_{CC} line



2 Ordering information scheme

Figure 18. Ordering information scheme



3 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Figure 19. WLCSP package dimensions

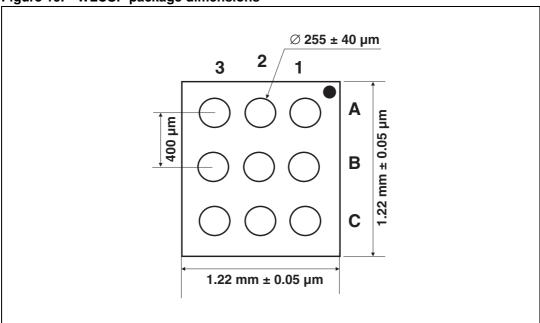
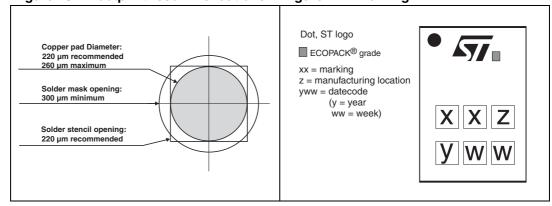


Figure 20. Footprint recommendations Figure 21. Marking



Dot identifying Pin A1 location 2.0 ± 0.05 4.0 ± 0.10 0.20 ± 0.02 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00

Figure 22. Tape and reel specification

Note:

More information is available in the application notes:

AN2348, "IPAD™ 400 µm Flip Chip: package description and recommendations for use" AN1751, "EMI filters: recommendations and measurements"

4 Ordering information

Table 3. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
EMIF03-SIM05F3	LB	WLCSP	1.9 mg	5000	Tape and reel (7")

5 Revision history

Table 4. Document revision history

Date	Revision	Changes
12-Nov-2012	1	Initial release.

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